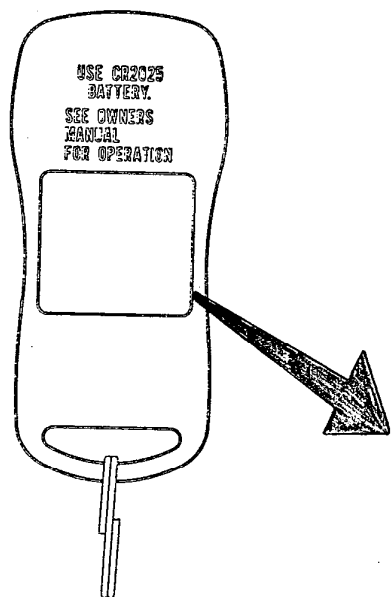


### 3. LABELING OF EQUIPMENT

Herewith the applicant, CALSONIC KANSEI CORPORATION, declares that the labeling is molded on the back surface of the transmitter housing as shown in Figure 3-1 and 3-2.



|                     |      |
|---------------------|------|
| MODEL:*****         | (20) |
| FCCID:*****         |      |
| CANADA:*****        |      |
| CK Electronics, LLC |      |
| (20)                |      |

|                                 |
|---------------------------------|
| MODEL:*****                     |
| FCCID:*****                     |
| CANADA:*****                    |
| CALSONIC KANSEI CORP.           |
| BRAND NAME <input type="text"/> |

①NISSAN  
②INFINITI

Figure 3-1 : Location of label

Figure3-2 : Label

Signature of applicant

|                 |                                                                                            |
|-----------------|--------------------------------------------------------------------------------------------|
| Name            | Title                                                                                      |
| Yasuo Nakamura, | General Manager, Research & Development Planning Department<br>CALSONIC KANSEI CORPORATION |

FCC ID: